

## DOCUMENT CHANGE REQUEST

DCR number 1679 Changes required for: General Originator: Torsten Schmidt

Date: 2024/11/07 Date sent: 2024/07/29 Organisation: Isabellenhuette

Heusler GmbH & Co.

Status: IMPLEMENTED

Title:	Resistor Fixed Chip Metal Foil, based on Type SMP-PW, SMS-PW, SMT-PW								
Number:	4001/027	Issue:	8						
Other documents affected:									
Page:									
see changed notes in attached file (DS 4001/027 Draft)									
Paragraph:									
see changed notes in attached file (DS 4001/027 Draft)									
Original wording:									
see changed notes in attached file (DS 4001/027 Draft)									
Proposed wording:									
see changed notes in attached file (DS 4001/027 Draft)									
Justification:									
upgrading to higher ohmic component values (Type SMT)									
Attachments:									
escc4001027iss9_draft_a_in_review.docx									
Modifications:									
DCR1679 is considered acceptable.									

Several additional editorial changes are proposed to be included with DCR1679 as follows and as implemented in the below attached spec mark-up per this DCR:

Additional changes:

The following DCR modifications are proposed as per the attached spec mark-up Draft

9A:

Para 1.4.2 (& 1.5): add additional column in Table 1.4.2 for Rated Dissipation (due to the

difference between Variant 03 and new Variant 07)

Appendix A: several minor editorial changes (see yellow highlights for details)

Approval signature:

Date signed:			
2024-11-07			